



Product Change Notification

#113486 – 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 113486-00

Change Title: Intel® Thermal Solution BXTS13X Labeling changes, PCN 113486-00, Label

Date of Publication: January 2, 2015

Key Characteristics of the Change:

Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	February 2, 2015
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Description of Change to the Customer:

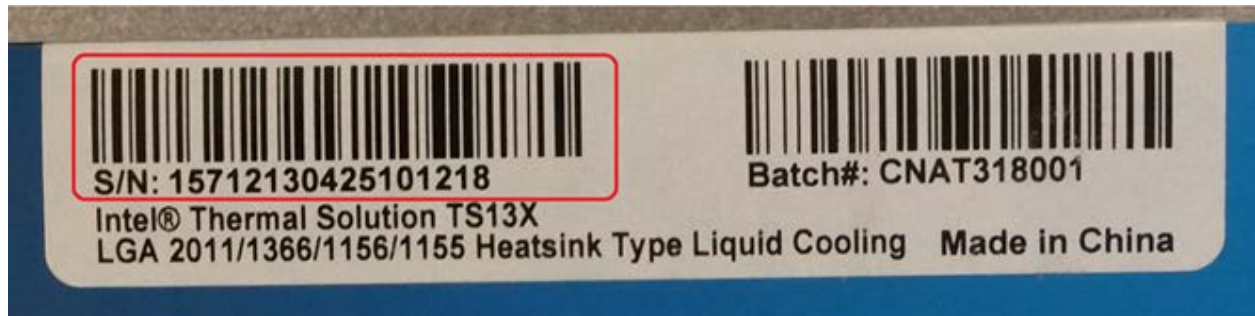
Intel will be removing the serial numbers from the Retail Carton label and the Outer Case label on the Intel® Thermal Solution BXTS13X packaging.

Intel will also be removing the “RoHS Compliant” text on the Outer Case label. This does not change the Intel® Thermal Solution BXTS13X RoHS compliance status, only the label text is being removed.

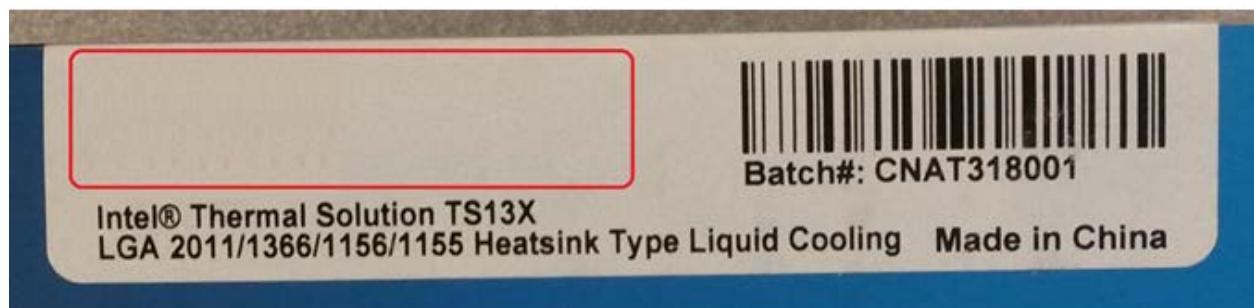
No change will be made to the Intel® Thermal Solution BXTS13X heat exchanger, the product will still have the individual unit serial number.

See examples below:

Current BXTS13X Retail Carton Label with serial number



New BXTS13X Retail Carton Label without serial number



Current BXTS13X Outer Case label with serial number



New BXTS13X Outer Case label without serial number



Customer Impact of Change and Recommended Action:

These label changes will only impact the product packaging labels. There is no change to the product functionality, product codes or the ordering process.

No impact or action is needed by customers. Customers may see a mix of products until inventory of the Intel® Thermal Solution BXTS13X packaging labels with serial numbers have been depleted.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#
Thermal Solution BXTS13X	BXTS13X	929672

PCN Revision History:

Date of Revision:

January 2, 2015

Revision Number:

00

Reason:

Originally Published PCN